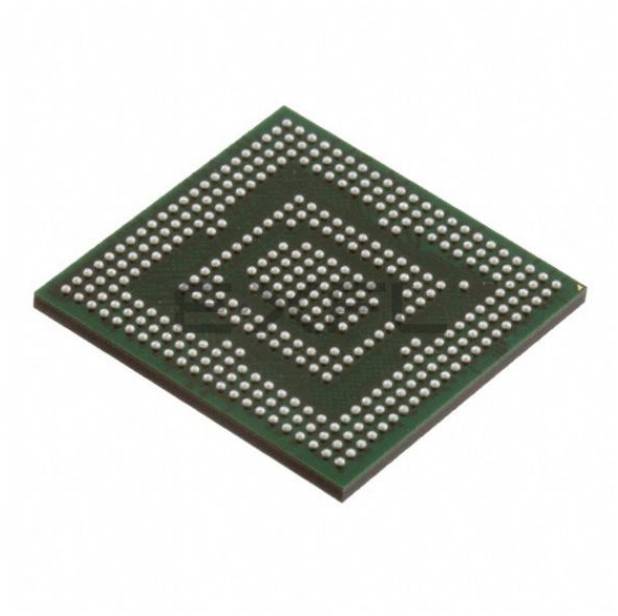

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Understanding Embedded - DSP (Digital Signal Processors)

Embedded - DSP (Digital Signal Processors) are specialized microprocessors designed to perform complex mathematical computations on digital signals in real-time. Unlike general-purpose processors, DSPs are optimized for high-speed numeric processing tasks, making them ideal for applications that require efficient and precise manipulation of digital data. These processors are fundamental in converting and processing signals in various forms, including audio, video, and communication signals, ensuring that data is accurately interpreted and utilized in embedded systems.

Applications of Embedded - DSP (Digital Signal Processors)

Details	
Product Status	Active
Type	Floating Point
Interface	CAN, EBI/EMI, Ethernet, DAI, I²C, MMC/SD/SDIO, SPI, SPORT, UART/USART, USB OTG
Clock Rate	500MHz
Non-Volatile Memory	ROM (512kB)
On-Chip RAM	640kB
Voltage - I/O	3.30V
Voltage - Core	1.10V
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	349-LFBGA, CSPBGA
Supplier Device Package	349-CSPBGA (19x19)
Purchase URL	https://www.e-xfl.com/product-detail/analog-devices/adsp-sc584bbcz-5a

ADC Control Module (ACM) Interface

The ADC control module (ACM) provides an interface that synchronizes the controls between the processors and an ADC. The analog-to-digital conversions are initiated by the processors, based on external or internal events.

The ACM allows for flexible scheduling of sampling instants and provides precise sampling signals to the ADC.

The ACM synchronizes the ADC conversion process, generating the ADC controls, the ADC conversion start signal, and other signals. The actual data acquisition from the ADC is done by an internal DAI routing of the ACM with the SPORT0 block.

The processors interface directly to many ADCs without any glue logic required.

3-Phase Pulse Width Modulator (PWM) Units

The pulse width modulator (PWM) module is a flexible and programmable waveform generator. With minimal CPU intervention, the PWM generates complex waveforms for motor control, pulse coded modulation (PCM), DAC conversions, power switching, and power conversion. The PWM module has four PWM pairs capable of 3-phase PWM generation for source inverters for ac induction and dc brushless motors.

Each of the three 3-phase PWM generation units features the following:

- 16-bit center-based PWM generation unit
- Programmable PWM pulse width
- Single update mode with an option for asymmetric duty
- Programmable dead time and switching frequency
- Programmable dead time per channel
- Twos complement implementation which permits smooth transition to full on and full off states
- Dedicated asynchronous PWM shutdown signal

Ethernet Media Access Controller (EMAC)

The processor features two ethernet media access controllers (EMACs): 10/100 Ethernet and 10/100/1000/AVB Ethernet with precision time protocol IEEE 1588.

The processors can directly connect to a network through embedded fast EMAC that supports 10-BaseT (10 Mb/sec), 100-BaseT (100 Mb/sec) and 1000-BaseT (1 Gb/sec) operations. The 10/100 EMAC peripheral on the processors is fully compliant to the IEEE 802.3-2002 standard. The peripheral provides programmable features designed to minimize supervision, bus use, or message processing by the rest of the processor system.

Some standard features of the EMAC are as follows:

- Support and RMII/RGMII protocols for external PHYs
- Full-duplex and half-duplex modes
- Media access management (in half-duplex operation)
- Flow control
- Station management, including the generation of MDC/MDIO frames for read/write access to PHY registers

Some advanced features of the EMAC are as follows:

- Automatic checksum computation of IP header and IP payload fields of receive frames
- Independent 32-bit descriptor driven receive and transmit DMA channels
- Frame status delivery to memory through DMA, including frame completion semaphores for efficient buffer queue management in software
- Transmit DMA support for separate descriptors for MAC header and payload fields to eliminate buffer copy operations
- Convenient frame alignment modes
- 47 MAC management statistics counters with selectable clear on read behavior and programmable interrupts on half maximum value
- Advanced power management
- Magic packet detection and wakeup frame filtering
- Support for 802.3Q tagged VLAN frames
- Programmable MDC clock rate and preamble suppression

Audio Video Bridging (AVB) Support (10/100/1000 EMAC Only)

The 10/100/1000 EMAC supports the following audio video (AVB) features:

- Separate channels or queues for AV data transfer in 100 Mbps and 1000 Mbps modes
- IEEE 802.1-Qav specified credit-based shaper (CBS) algorithm for the additional transmit channels
- Configuring up to two additional channels (Channel 1 and Channel 2) on the transmit and receive paths for AV traffic. Channel 0 is available by default and carries the legacy best effort Ethernet traffic on the transmit side.
- Separate DMA, transmit and receive FIFO for AVB latency class
- Programmable control to route received VLAN tagged non AV packets to channels or queues

Precision Time Protocol (PTP) IEEE 1588 Support

The IEEE 1588 standard is a precision clock synchronization protocol for networked measurement and control systems. The processors include hardware support for IEEE 1588 with an integrated precision time protocol synchronization engine (PTP_TSYNC).

This engine provides hardware assisted time stamping to improve the accuracy of clock synchronization between PTP nodes. The main features of the engine are as follows:

- Support for both IEEE 1588-2002 and IEEE 1588-2008 protocol standards
- Hardware assisted time stamping capable of up to 12.5 ns resolution
- Lock adjustment

SYSTEM ACCELERATION

The following sections describe the system acceleration blocks of the ADSP-SC58x/ADSP-2158x processors.

FFT/IFFT Accelerator

A high performance FFT/IFFT accelerator is available to improve the overall floating-point computation power of the ADSP-SC58x/ADSP-2158x processors.

The following features are available to improve the overall performance of the FFT/IFFT accelerator:

- Support for the IEEE-754/854 single-precision floating-point data format.
- Automatic twiddle factor generation to reduce system bandwidth.
- Support for a vector complex multiply for windowing and frequency domain filtering.
- Ability to pipeline the data flow. This allows the accelerator to bring in a new data set while the current data set is processed and the previous data set is sent out to memory. This can provide a significant system level performance improvement.
- Ability to output the result as the magnitude squared of the complex samples.
- Dedicated, high speed DMA controller with 64-bit buses that can read and write data from any memory space.

The FFT/IFFT accelerator can run concurrently with the other accelerators on the processor.

Finite Impulse Response (FIR) Accelerator

The finite impulse response (FIR) accelerator consists of a 1024 word coefficient memory, a 1024 word deep delay line for the data, and four MAC units. A controller manages the accelerator. The FIR accelerator runs at the peripheral clock frequency. The FIR accelerator can access all memory spaces and can run concurrently with the other accelerators on the processor.

Infinite Impulse Response (IIR) Accelerator

The infinite impulse response (IIR) accelerator consists of a 1440 word coefficient memory for storage of biquad coefficients, a data memory for storing the intermediate data, and one MAC unit. A controller manages the accelerator. The IIR accelerator runs at the peripheral clock frequency. The IIR accelerator can access all memory spaces and run concurrently with the other accelerators on the processor.

Harmonic Analysis Engine (HAE)

The harmonic analysis engine (HAE) block receives 8 kHz input samples from two source signals whose frequencies are between 45 Hz and 65 Hz. The HAE processes the input samples and produces output results. The output results consist of power quality measurements of the fundamental and up to 12 additional harmonics.

Sinus Cardinalis (SINC) Filter

The sinus cardinalis (SINC) filter module processes four bit streams using a pair of configurable SINC filters for each bit stream. The purpose of the primary SINC filter of each pair is to produce the filtered and decimated output for the pair. The output can decimate any integer rate between 8 and 256 times lower than the input rate. Greater decimation allows greater removal of noise, and, therefore, greater effective number of bits (ENOB).

Optional additional filtering outside the SINC module can further increase ENOB. The primary SINC filter output is accessible through transfer to processor memory, or to another peripheral, via DMA.

Each of the four channels is also provided with a low latency secondary filter with programmable positive and negative overrange detection comparators. These limit detection events can interrupt the core, generate a trigger, or signal a system fault.

Digital Transmission Content Protection (DTCP)

Contact Analog Devices for more information on DTCP.

SYSTEM DESIGN

The following sections provide an introduction to system design features and power supply issues.

Clock Management

The processors provide three operating modes, each with a different performance and power profile. Control of clocking to each of the processor peripherals reduces power consumption. The processors do not support any low power operation modes. Control of clocking to each of the processor peripherals can reduce the power consumption.

Reset Control Unit (RCU)

Reset is the initial state of the whole processor, or the core, and is the result of a hardware or software triggered event. In this state, all control registers are set to default values and functional units are idle. Exiting a full system reset starts with the core ready to boot.

The reset control unit (RCU) controls how all the functional units enter and exit reset. Differences in functional requirements and clocking constraints define how reset signals are generated. Programs must guarantee that none of the reset functions put the system into an undefined state or causes resources to stall. This is particularly important when the core resets (programs must ensure that there is no pending system activity involving the core when it is reset).

From a system perspective, reset is defined by both the reset target and the reset source.

Table 12. ADSP-SC58x/ADSP-2158x 349-Ball CSP_BGA Signal Descriptions (Continued)

Signal Name	Description	Port	Pin Name
HADC0_VIN5	HADC0 Analog Input at channel 5	Not Muxed	HADC0_VIN5
HADC0_VIN6	HADC0 Analog Input at channel 6	Not Muxed	HADC0_VIN6
HADC0_VIN7	HADC0 Analog Input at channel 7	Not Muxed	HADC0_VIN7
HADC0_VREFN	HADC0 Ground Reference for ADC	Not Muxed	HADC0_VREFN
HADC0_VREFP	HADC0 External Reference for ADC	Not Muxed	HADC0_VREFP
JTG_TCK	TAPC JTAG Clock	Not Muxed	JTG_TCK
JTG_TDI	TAPC JTAG Serial Data In	Not Muxed	JTG_TDI
JTG_TDO	TAPC JTAG Serial Data Out	Not Muxed	JTG_TDO
JTG_TMS	TAPC JTAG Mode Select	Not Muxed	JTG_TMS
$\overline{\text{JTG\_TRST}}$	TAPC JTAG Reset	Not Muxed	$\overline{\text{JTG\_TRST}}$
LP0_ACK	LP0 Acknowledge	D	PD_11
LP0_CLK	LP0 Clock	D	PD_10
LP0_D0	LP0 Data 0	D	PD_02
LP0_D1	LP0 Data 1	D	PD_03
LP0_D2	LP0 Data 2	D	PD_04
LP0_D3	LP0 Data 3	D	PD_05
LP0_D4	LP0 Data 4	D	PD_06
LP0_D5	LP0 Data 5	D	PD_07
LP0_D6	LP0 Data 6	D	PD_08
LP0_D7	LP0 Data 7	D	PD_09
LP1_ACK	LP1 Acknowledge	B	PB_15
LP1_CLK	LP1 Clock	C	PC_00
LP1_D0	LP1 Data 0	B	PB_07
LP1_D1	LP1 Data 1	B	PB_08
LP1_D2	LP1 Data 2	B	PB_09
LP1_D3	LP1 Data 3	B	PB_10
LP1_D4	LP1 Data 4	B	PB_11
LP1_D5	LP1 Data 5	B	PB_12
LP1_D6	LP1 Data 6	B	PB_13
LP1_D7	LP1 Data 7	B	PB_14
MLB0_CLKN	MLB0 Negative Differential Clock (–)	Not Muxed	MLB0_CLKN
MLB0_CLKP	MLB0 Positive Differential Clock (+)	Not Muxed	MLB0_CLKP
MLB0_DATN	MLB0 Negative Differential Data (–)	Not Muxed	MLB0_DATN
MLB0_DATP	MLB0 Positive Differential Data (+)	Not Muxed	MLB0_DATP
MLB0_SIGN	MLB0 Negative Differential Signal (–)	Not Muxed	MLB0_SIGN
MLB0_SIGP	MLB0 Positive Differential Signal (+)	Not Muxed	MLB0_SIGP
MLB0_CLK	MLB0 Single-Ended Clock	B	PB_04
MLB0_DAT	MLB0 Single-Ended Data	B	PB_06
MLB0_SIG	MLB0 Single-Ended Signal	B	PB_05
MLB0_CLKOUT	MLB0 Single-Ended Clock Out	D	PD_14
PA_00-15	PORTA Position 00 through Position 15	A	PA_00-15
PB_00-15	PORTB Position 00 through Position 15	B	PB_00-15
PC_00-15	PORTC Position 00 through Position 15	C	PC_00-15
PD_00-15	PORTD Position 00 through Position 15	D	PD_00-15
PE_00-15	PORTE Position 00 through Position 15	E	PE_00-15
PPI0_CLK	EPPI0 Clock	E	PE_03
PPI0_D00	EPPI0 Data 0	E	PE_12
PPI0_D01	EPPI0 Data 1	E	PE_11

Table 19. ADSP-SC58x/ADSP-2158x 529-Ball CSP_BGA Signal Descriptions (Continued)

Signal Name	Description	Port	Pin Name
DAI0_PIN15	DAI0 Pin 15	Not Muxed	DAI0_PIN15
DAI0_PIN16	DAI0 Pin 16	Not Muxed	DAI0_PIN16
DAI0_PIN17	DAI0 Pin 17	Not Muxed	DAI0_PIN17
DAI0_PIN18	DAI0 Pin 18	Not Muxed	DAI0_PIN18
DAI0_PIN19	DAI0 Pin 19	Not Muxed	DAI0_PIN19
DAI0_PIN20	DAI0 Pin 20	Not Muxed	DAI0_PIN20
DAI1_PIN01	DAI1 Pin 1	Not Muxed	DAI1_PIN01
DAI1_PIN02	DAI1 Pin 2	Not Muxed	DAI1_PIN02
DAI1_PIN03	DAI1 Pin 3	Not Muxed	DAI1_PIN03
DAI1_PIN04	DAI1 Pin 4	Not Muxed	DAI1_PIN04
DAI1_PIN05	DAI1 Pin 5	Not Muxed	DAI1_PIN05
DAI1_PIN06	DAI1 Pin 6	Not Muxed	DAI1_PIN06
DAI1_PIN07	DAI1 Pin 7	Not Muxed	DAI1_PIN07
DAI1_PIN08	DAI1 Pin 8	Not Muxed	DAI1_PIN08
DAI1_PIN09	DAI1 Pin 9	Not Muxed	DAI1_PIN09
DAI1_PIN10	DAI1 Pin 10	Not Muxed	DAI1_PIN10
DAI1_PIN11	DAI1 Pin 11	Not Muxed	DAI1_PIN11
DAI1_PIN12	DAI1 Pin 12	Not Muxed	DAI1_PIN12
DAI1_PIN13	DAI1 Pin 13	Not Muxed	DAI1_PIN13
DAI1_PIN14	DAI1 Pin 14	Not Muxed	DAI1_PIN14
DAI1_PIN15	DAI1 Pin 15	Not Muxed	DAI1_PIN15
DAI1_PIN16	DAI1 Pin 16	Not Muxed	DAI1_PIN16
DAI1_PIN17	DAI1 Pin 17	Not Muxed	DAI1_PIN17
DAI1_PIN18	DAI1 Pin 18	Not Muxed	DAI1_PIN18
DAI1_PIN19	DAI1 Pin 19	Not Muxed	DAI1_PIN19
DAI1_PIN20	DAI1 Pin 20	Not Muxed	DAI1_PIN20
DMC0_A00	DMC0 Address 0	Not Muxed	DMC0_A00
DMC0_A01	DMC0 Address 1	Not Muxed	DMC0_A01
DMC0_A02	DMC0 Address 2	Not Muxed	DMC0_A02
DMC0_A03	DMC0 Address 3	Not Muxed	DMC0_A03
DMC0_A04	DMC0 Address 4	Not Muxed	DMC0_A04
DMC0_A05	DMC0 Address 5	Not Muxed	DMC0_A05
DMC0_A06	DMC0 Address 6	Not Muxed	DMC0_A06
DMC0_A07	DMC0 Address 7	Not Muxed	DMC0_A07
DMC0_A08	DMC0 Address 8	Not Muxed	DMC0_A08
DMC0_A09	DMC0 Address 9	Not Muxed	DMC0_A09
DMC0_A10	DMC0 Address 10	Not Muxed	DMC0_A10
DMC0_A11	DMC0 Address 11	Not Muxed	DMC0_A11
DMC0_A12	DMC0 Address 12	Not Muxed	DMC0_A12
DMC0_A13	DMC0 Address 13	Not Muxed	DMC0_A13
DMC0_A14	DMC0 Address 14	Not Muxed	DMC0_A14
DMC0_A15	DMC0 Address 15	Not Muxed	DMC0_A15
DMC0_BA0	DMC0 Bank Address 0	Not Muxed	DMC0_BA0
DMC0_BA1	DMC0 Bank Address 1	Not Muxed	DMC0_BA1
DMC0_BA2	DMC0 Bank Address 2	Not Muxed	DMC0_BA2
$\overline{\text{DMC0\_CAS}}$	DMC0 Column Address Strobe	Not Muxed	$\overline{\text{DMC0\_CAS}}$
DMC0_CK	DMC0 Clock	Not Muxed	DMC0_CK
DMC0_CKE	DMC0 Clock enable	Not Muxed	DMC0_CKE

Table 19. ADSP-SC58x/ADSP-2158x 529-Ball CSP_BGA Signal Descriptions (Continued)

Signal Name	Description	Port	Pin Name
ETH0_RXD0	ETH0 Receive Data 0	A	PA_04
ETH0_RXD1	ETH0 Receive Data 1	A	PA_05
ETH0_RXD2	ETH0 Receive Data 2	A	PA_08
ETH0_RXD3	ETH0 Receive Data 3	A	PA_09
ETH0_TXCLK	ETH0 Transmit Clock	A	PA_11
ETH0_TXCTL_TXEN	ETH0 TXCTL (GigE) or TXEN (10/100)	A	PA_10
ETH0_TXD0	ETH0 Transmit Data 0	A	PA_00
ETH0_TXD1	ETH0 Transmit Data 1	A	PA_01
ETH0_TXD2	ETH0 Transmit Data 2	A	PA_12
ETH0_TXD3	ETH0 Transmit Data 3	A	PA_13
ETH0_TXEN	ETH0 Transmit Enable	A	PA_10
ETH1_CRS	ETH1 Carrier Sense/RMII Receive Data Valid	F	PF_13
ETH1_MDC	ETH1 Management Channel Clock	F	PF_14
ETH1_MDIO	ETH1 Management Channel Serial Data	F	PF_15
ETH1_REFCLK	ETH1 Reference Clock	G	PG_00
ETH1_RXD0	ETH1 Receive Data 0	G	PG_04
ETH1_RXD1	ETH1 Receive Data 1	G	PG_05
ETH1_TXD0	ETH1 Transmit Data 0	G	PG_02
ETH1_TXD1	ETH1 Transmit Data 1	G	PG_03
ETH1_TXEN	ETH1 Transmit Enable	G	PG_01
HADC0_EOC_DOUT	HADC0 End of Conversion / Serial Data Out	F	PF_02
HADC0_MUX0	HADC0 Controls to external multiplexer	F	PF_05
HADC0_MUX1	HADC0 Controls to external multiplexer	F	PF_04
HADC0_MUX2	HADC0 Controls to external multiplexer	F	PF_03
HADC0_VIN0	HADC0 Analog Input at channel 0	Not Muxed	HADC0_VIN0
HADC0_VIN1	HADC0 Analog Input at channel 1	Not Muxed	HADC0_VIN1
HADC0_VIN2	HADC0 Analog Input at channel 2	Not Muxed	HADC0_VIN2
HADC0_VIN3	HADC0 Analog Input at channel 3	Not Muxed	HADC0_VIN3
HADC0_VIN4	HADC0 Analog Input at channel 4	Not Muxed	HADC0_VIN4
HADC0_VIN5	HADC0 Analog Input at channel 5	Not Muxed	HADC0_VIN5
HADC0_VIN6	HADC0 Analog Input at channel 6	Not Muxed	HADC0_VIN6
HADC0_VIN7	HADC0 Analog Input at channel 7	Not Muxed	HADC0_VIN7
HADC0_VREFN	HADC0 Ground Reference for ADC	Not Muxed	HADC0_VREFN
HADC0_VREFP	HADC0 External Reference for ADC	Not Muxed	HADC0_VREFP
JTG_TCK	TAPC JTAG Clock	Not Muxed	JTG_TCK
JTG_TDI	TAPC JTAG Serial Data In	Not Muxed	JTG_TDI
JTG_TDO	TAPC JTAG Serial Data Out	Not Muxed	JTG_TDO
JTG_TMS	TAPC JTAG Mode Select	Not Muxed	JTG_TMS
$\overline{\text{JTG\_TRST}}$	TAPC JTAG Reset	Not Muxed	$\overline{\text{JTG\_TRST}}$
LP0_ACK	LP0 Acknowledge	D	PD_11
LP0_CLK	LP0 Clock	D	PD_10
LP0_D0	LP0 Data 0	D	PD_02
LP0_D1	LP0 Data 1	D	PD_03
LP0_D2	LP0 Data 2	D	PD_04
LP0_D3	LP0 Data 3	D	PD_05
LP0_D4	LP0 Data 4	D	PD_06
LP0_D5	LP0 Data 5	D	PD_07
LP0_D6	LP0 Data 6	D	PD_08

Table 27. ADSP-SC58x/ADSP-2158x Designer Quick Reference (Continued)

Signal Name	Type	Driver Type	Int Term	Reset Term	Reset Drive	Power Domain	Description and Notes
DMC0_UDQS	InOut	C	Internal logic ensures that input signal does not float	none	none	VDD_DMC	Desc: DMC0 Data Strobe for Upper Byte (complement) Notes: No notes
DMC0_VREF	a		none	none	none	VDD_DMC	Desc: DMC0 Voltage Reference Notes: No notes
DMC0_WE	Output	B	none	none	none	VDD_DMC	Desc: DMC0 Write Enable Notes: No notes
DMC1_A00	Output	B	none	none	none	VDD_DMC	Desc: DMC1 Address 0 Notes: No notes
DMC1_A01	Output	B	none	none	none	VDD_DMC	Desc: DMC1 Address 1 Notes: No notes
DMC1_A02	Output	B	none	none	none	VDD_DMC	Desc: DMC1 Address 2 Notes: No notes
DMC1_A03	Output	B	none	none	none	VDD_DMC	Desc: DMC1 Address 3 Notes: No notes
DMC1_A04	Output	B	none	none	none	VDD_DMC	Desc: DMC1 Address 4 Notes: No notes
DMC1_A05	Output	B	none	none	none	VDD_DMC	Desc: DMC1 Address 5 Notes: No notes
DMC1_A06	Output	B	none	none	none	VDD_DMC	Desc: DMC1 Address 6 Notes: No notes
DMC1_A07	Output	B	none	none	none	VDD_DMC	Desc: DMC1 Address 7 Notes: No notes
DMC1_A08	Output	B	none	none	none	VDD_DMC	Desc: DMC1 Address 8 Notes: No notes
DMC1_A09	Output	B	none	none	none	VDD_DMC	Desc: DMC1 Address 9 Notes: No notes
DMC1_A10	Output	B	none	none	none	VDD_DMC	Desc: DMC1 Address 10 Notes: No notes
DMC1_A11	Output	B	none	none	none	VDD_DMC	Desc: DMC1 Address 11 Notes: No notes
DMC1_A12	Output	B	none	none	none	VDD_DMC	Desc: DMC1 Address 12 Notes: No notes
DMC1_A13	Output	B	none	none	none	VDD_DMC	Desc: DMC1 Address 13 Notes: No notes
DMC1_A14	Output	B	none	none	none	VDD_DMC	Desc: DMC1 Address 14 Notes: No notes
DMC1_A15	Output	B	none	none	none	VDD_DMC	Desc: DMC1 Address 15 Notes: No notes
DMC1_BA0	Output	B	none	none	none	VDD_DMC	Desc: DMC1 Bank Address Input 0 Notes: No notes
DMC1_BA1	Output	B	none	none	none	VDD_DMC	Desc: DMC1 Bank Address Input 1 Notes: No notes

Table 27. ADSP-SC58x/ADSP-2158x Designer Quick Reference (Continued)

Signal Name	Type	Driver Type	Int Term	Reset Term	Reset Drive	Power Domain	Description and Notes
HADC0_VREFN	s	NA	none	none	none	VDD_HADC	Desc: HADC0 Ground Reference for ADC Notes: No notes
HADC0_VREFP	s	NA	none	none	none	VDD_HADC	Desc: HADC0 External Reference for ADC Notes: No notes
JTG_TCK	Input		PullUp	none	none	VDD_EXT	Desc: JTAG Clock Notes: No notes
JTG_TDI	Input		PullUp	none	none	VDD_EXT	Desc: JTAG Serial Data In Notes: No notes
JTG_TDO	Output	A	none	none	none	VDD_EXT	Desc: JTAG Serial Data Out Notes: No notes
JTG_TMS	InOut	A	PullUp	none	none	VDD_EXT	Desc: JTAG Mode Select Notes: No notes
$\overline{\text{JTG\_TRST}}$	Input		PullDown	none	none	VDD_EXT	Desc: JTAG Reset Notes: No notes
MLB0_CLKN	Input	NA	Internal logic ensures that input signal does not float	none	none	VDD_EXT	Desc: MLB0 Differential Clock (-) Notes: No notes
MLB0_CLKP	Input	NA	Internal logic ensures that input signal does not float	none	none	VDD_EXT	Desc: MLB0 Differential Clock (+) Notes: No notes
MLB0_DATN	InOut	I	Internal logic ensures that input signal does not float	none	none	VDD_EXT	Desc: MLB0 Differential Data (-) Notes: No notes
MLB0_DATP	InOut	I	Internal logic ensures that input signal does not float	none	none	VDD_EXT	Desc: MLB0 Differential Data (+) Notes: No notes
MLB0_SIGN	InOut	I	Internal logic ensures that input signal does not float	none	none	VDD_EXT	Desc: MLB0 Differential Signal (-) Notes: No notes
MLB0_SIGP	InOut	I	Internal logic ensures that input signal does not float	none	none	VDD_EXT	Desc: MLB0 Differential Signal (+) Notes: No notes
PA_00	InOut	A	PullDown	none	none	VDD_EXT	Desc: PORTA Position 0 | EMAC0 Transmit Data 0 | SMC0 Address 21 Notes: No notes
PA_01	InOut	A	PullDown	none	none	VDD_EXT	Desc: PORTA Position 1 | EMAC0 Transmit Data 1 | SMC0 Address 20 Notes: No notes

Table 27. ADSP-SC58x/ADSP-2158x Designer Quick Reference (Continued)

Signal Name	Type	Driver Type	Int Term	Reset Term	Reset Drive	Power Domain	Description and Notes
PC_00	InOut	H	PullDown	none	none	VDD_EXT	Desc: PORTC Position 0 | LP1 Clock | PWM0 Channel B Low Side | SMC0 Read Enable | SPI0 Slave Select Output 4 Notes: No notes
PC_01	InOut	A	PullDown	none	none	VDD_EXT	Desc: PORTC Position 1 | SPI2 Clock Notes: No notes
PC_02	InOut	A	PullDown	none	none	VDD_EXT	Desc: PORTC Position 2 | SPI2 Master In, Slave Out Notes: No notes
PC_03	InOut	A	PullDown	none	none	VDD_EXT	Desc: PORTC Position 3 | SPI2 Master Out, Slave In Notes: No notes
PC_04	InOut	A	PullDown	none	none	VDD_EXT	Desc: PORTC Position 4 | SPI2 Data 2 Notes: No notes
PC_05	InOut	A	PullDown	none	none	VDD_EXT	Desc: PORTC Position 5 | SPI2 Data 3 Notes: No notes
PC_06	InOut	A	PullDown	none	none	VDD_EXT	Desc: PORTC Position 6 | SPI2 Slave Select Output 1 | SPI2 Slave Select Input Notes: No notes
PC_07	InOut	A	PullDown	none	none	VDD_EXT	Desc: PORTC Position 7 | CAN0 Receive | SMC0 Memory Select 2 | SPI0 Slave Select Output 1 | TIMER0 Alternate Capture Input 3 Notes: No notes
PC_08	InOut	A	PullDown	none	none	VDD_EXT	Desc: PORTC Position 8 | CAN0 Transmit | SMC0 Memory Select 3 Notes: No notes
PC_09	InOut	A	PullDown	none	none	VDD_EXT	Desc: PORTC Position 9 | SPI0 Clock Notes: No notes
PC_10	InOut	H	PullDown	none	none	VDD_EXT	Desc: PORTC Position 10 | SPI0 Master In, Slave Out Notes: No notes
PC_11	InOut	A	PullDown	none	none	VDD_EXT	Desc: PORTC Position 11 | SPI0 Master Out, Slave In | TIMER0 Clock Notes: No notes
PC_12	InOut	A	PullDown	none	none	VDD_EXT	Desc: PORTC Position 12 | ACM0 External Trigger n | SMC0 Address 25 | SPI0 Ready | SPI0 Slave Select Output 3 Notes: No notes

Table 27. ADSP-SC58x/ADSP-2158x Designer Quick Reference (Continued)

Signal Name	Type	Driver Type	Int Term	Reset Term	Reset Drive	Power Domain	Description and Notes
PE_12	InOut	A	PullDown	none	none	VDD_EXT	Desc: PORTE Position 12 | EPPI0 Data 0 | SMC0 Data 0 | SPI1 Slave Select Output 4 | SPI2 Ready Notes: No notes
PE_13	InOut	A	PullDown	none	none	VDD_EXT	Desc: PORTE Position 13 | EPPI0 Data 20 | SMC0 Memory Select 1 | SPI1 Clock Notes: No notes
PE_14	InOut	A	PullDown	none	none	VDD_EXT	Desc: PORTE Position 14 | EPPI0 Data 21 | SMC0 Byte Enable 0 | SPI1 Master In, Slave Out Notes: No notes
PE_15	InOut	A	PullDown	none	none	VDD_EXT	Desc: PORTE Position 15 | EPPI0 Data 22 | SMC0 Byte Enable 1 | SPI1 Master Out, Slave In Notes: No notes
PF_00	InOut	A	PullDown	none	none	VDD_EXT	Desc: PORTF Position 0 | SPI1 Slave Select Output 6 | TIMER0 Timer 6 Notes: No notes
PF_01	InOut	A	PullDown	none	none	VDD_EXT	Desc: PORTF Position 1 | SPI1 Slave Select Output 7 | TIMER0 Timer 7 Notes: No notes
PF_02	InOut	A	PullDown/ Programmable PullUp	none	none	VDD_EXT	Desc: PORTF Position 2 | HADC0 End of Conversion / Serial Data Out | MSI0 Data 0 Notes: No notes
PF_03	InOut	A	PullDown/ Programmable PullUp	none	none	VDD_EXT	Desc: PORTF Position 3 | HADC0 Controls to external multiplexer | MSI0 Data 1 Notes: No notes
PF_04	InOut	A	PullDown/ Programmable PullUp	none	none	VDD_EXT	Desc: PORTF Position 4 | HADC0 Controls to external multiplexer | MSI0 Data 2 Notes: No notes
PF_05	InOut	A	PullDown/ Programmable PullUp	none	none	VDD_EXT	Desc: PORTF Position 5 | HADC0 Controls to external multiplexer | MSI0 Data 3 Notes: No notes
PF_06	InOut	A	PullDown/ Programmable PullUp	none	none	VDD_EXT	Desc: PORTF Position 6 | MSI0 Data 4 | PWM2 Channel A Low Side Notes: No notes
PF_07	InOut	A	PullDown/ Programmable PullUp	none	none	VDD_EXT	Desc: PORTF Position 7 | MSI0 Data 5 | PWM2 Channel A High Side Notes: No notes

SPECIFICATIONS

For information about product specifications, contact your Analog Devices, Inc. representative.

OPERATING CONDITIONS

Parameter		Conditions	Min	Nominal	Max	Unit
V_{DD_INT}	Internal (Core) Supply Voltage	CCLK ≤ 450 MHz	1.05	1.1	1.15	V
V_{DD_EXT}	External (I/O) Supply Voltage		3.13	3.3	3.47	V
V_{DD_HADC}	Analog Power Supply Voltage		3.13	3.3	3.47	V
V_{DD_DMC}[1]	DDR2/LPDDR Controller Supply Voltage		1.7	1.8	1.9	V
	DDR3 Controller Supply Voltage		1.425	1.5	1.575	V
V_{DD_USB}[2]	USB Supply Voltage		3.13	3.3	3.47	V
V_{DD_RTC}	RTC Voltage		2.0	3.3	3.60	V
$V_{DD\_PCIE\_TX}$	PCIe Core Transmit Voltage		1.05	1.1	1.15	V
$V_{DD\_PCIE\_RX}$	PCIe Core Receive Voltage		1.05	1.1	1.15	V
V_{DD_PCIE}	PCIe Voltage		3.13	3.3	3.47	V
V_{DDR_VREF}	DDR2 Reference Voltage		0.49 × V_{DD_DMC}	0.50 × V_{DD_DMC}	0.51 × V_{DD_DMC}	V
V_{HADC_REF}[3]	HADC Reference Voltage		2.5	3.30	V_{DD_HADC}	V
V_{HADC0_VINx}	HADC Input Voltage		0		V_{HADC_REF} + 0.2	V
V_{IH}[4]	High Level Input Voltage	V_{DD_EXT} = maximum	2.0			V
V_{IL}[4]	Low Level Input Voltage	V_{DD_EXT} = minimum			0.8	V
$V_{IL\_DDR2/3}$[5]	Low Level Input Voltage	V_{DD_DMC} = minimum			V_{REF} – 0.25	V
$V_{IH\_DDR2/3}$[5]	High Level Input Voltage	V_{DD_DMC} = maximum	V_{REF} + 0.25			V
V_{IL_LPDDR}[6]	Low Level Input Voltage	V_{DD_DMC} = minimum			0.2 × V_{DD_DMC}	V
V_{IH_LPDDR}[6]	High Level Input Voltage	V_{DD_DMC} = maximum	0.8 × V_{DD_DMC}			V
T_J	Junction Temperature 349-Lead CSP_BGA	$T_{AMBIENT}$ 0°C to +70°C	0		100	°C
T_J	Junction Temperature 349-Lead CSP_BGA	$T_{AMBIENT}$ –40°C to +85°C	–40		+110	°C
T_J	Junction Temperature 349-Lead CSP_BGA	$T_{AMBIENT}$ –40°C to +95°C	–40		+125	°C
T_J	Junction Temperature 529-Lead CSP_BGA	$T_{AMBIENT}$ 0°C to +70°C	0		110	°C
T_J	Junction Temperature 529-Lead CSP_BGA	$T_{AMBIENT}$ –40°C to +85°C	–40		+125	°C
AUTOMOTIVE USE ONLY						
T_J	Junction Temperature 349-Lead CSP_BGA (Automotive Grade)	$T_{AMBIENT}$ –40°C to +105°C	–40		+133[7]	°C

[1] Applies to DDR2/DDR3/LPDDR signals.
[2] If not used, V_{DD_USB} must be connected to 3.3V.
[3] V_{HADC_VREF} must always be less than V_{DD_HADC}.
[4] Parameter value applies to all input and bidirectional pins except the TWI, DMC, USB, PCIe, and MLB pins.
[5] This parameter applies to all DMC0/1 signals in DDR2/DDR3 mode. V_{REF} is the voltage applied to the V_{REF_DMC} pin, nominally $V_{DD\_DMC/2}$.
[6] This parameter applies to DMC0/1 signals in LPDDR mode.
[7] Automotive application use profile only. Not supported for nonautomotive use. Contact Analog Devices for more information.

Table 28. TWI_VSEL Selections and V_{DD_EXT}/V_{BUSTWI}

TWI_VSEL Selections	V_{DD_EXT} Nominal	V_{BUSTWI}			Unit
		Min	Nominal	Max	
TWI000[1]	3.30	3.13	3.30	3.47	V
TWI100	3.30	4.75	5.00	5.25	V

[1] Designs must comply with the V_{DD_EXT} and V_{BUSTWI} voltages specified for the default TWI_DT setting for correct JTAG boundary scan operation during reset.

Table 34. Dynamic Current for Each SHARC+ Core (mA, with ASF = 1.00)

	Voltage (V_{DD_INT})		
f_{CCLK} (MHz)	1.05	1.10	1.15
450	321.3	336.6	351.9
400	285.6	299.2	312.8
350	249.9	261.8	273.7
300	214.2	224.4	234.6
250	178.5	187.0	195.5
200	142.8	149.6	156.4
150	107.1	112.2	117.3
100	71.4	74.8	78.2

Table 35. Dynamic Current for the ARM Cortex-A5 Core (mA, with ASF = 1.00)

	Voltage (V_{DD_INT})		
f_{CCLK} (MHz)	1.05	1.10	1.15
450	70.88	74.25	77.63
400	63.00	66.00	69.00
350	55.13	57.75	60.38
300	47.25	49.50	51.75
250	39.38	41.25	43.13
200	31.50	33.00	34.50
150	23.63	24.75	25.88
100	15.75	16.50	17.25

The following equation is used to compute the power dissipation when the FFT accelerator is used:

$I_{DD\_INT\_ACCL\_DYN}$ (mA) = $ASF_{ACCL} \times f_{SYSCLK}$ (MHz) × V_{DD_INT} (V)

Table 36. Activity Scaling Factors for the FFT Accelerator (ASF_{ACCL})

I_{DD_INT} Power Vector	ASF_{ACCL}
Unused	0.0
I_{DD-TYP}	0.32

Clock Current

The dynamic clock currents provide the total power dissipated by all transistors switching in the clock paths. The power dissipated by each clock domain is dependent on voltage (V_{DD_INT}), operating frequency, and a unique scaling factor.

$I_{DD\_INT\_SYSCLK\_DYN}$ (mA) = 0.78 × f_{SYSCLK} (MHz) × V_{DD_INT} (V)

$I_{DD\_INT\_SCLK0\_DYN}$ (mA) = 0.44 × f_{SCLK0} (MHz) × V_{DD_INT} (V)

$I_{DD\_INT\_SCLK1\_DYN}$ (mA) = 0.06 × f_{SCLK1} (MHz) × V_{DD_INT} (V)

$I_{DD\_INT\_DCLK\_DYN}$ (mA) = 0.14 × f_{DCLK} (MHz) × V_{DD_INT} (V)

$I_{DD\_INT\_OCLK\_DYN}$ (mA) = 0.02 × f_{OCLK} (MHz) × V_{DD_INT} (V)

Current from High-Speed Peripheral Operation

The following modules contribute significantly to power dissipation, and a single term is added when they are used.

$I_{DD\_INT\_USB\_DYN}$ = 20 mA (if both USBs are enabled in HS mode)

$I_{DD\_INT\_MLB\_DYN}$ = 10 mA (if MLB 6-pin interface is enabled)

$I_{DD\_INT\_GIGE\_DYN}$ = 10 mA (if gigabit EMAC is enabled)

$I_{DD\_INT\_PCIE\_DYN}$ = 240 mA (if PCIe is enabled in 5 Gbps mode)

Data Transmission Current

The data transmission current represents the power dissipated when moving data throughout the system via direct memory access (DMA). This current is proportional to the data rate. Refer to the power calculator available with "Estimating Power for ADSP-SC58x/2158x SHARC+ Processors" (EE-392) to estimate $I_{DD\_INT\_DMA\_DR\_DYN}$ based on the bandwidth of the data transfer.

Asynchronous Flash Write

Table 49 and Figure 16 show asynchronous flash memory write timing, related to the SMC.

Table 49. Asynchronous Flash Write

Parameter		Min	Max	Unit
Switching Characteristics				
t_{AMSADV}	SMC0_Ax/$\overline{\text{SMC0\_AMSx}}$ Assertion Before ADV Low[1]	PREST × t_{SCLK0} – 2		ns
$t_{DADVAWE}$	$\overline{\text{SMC0\_AWE}}$ Low Delay From ADV High[2]	PREAT × t_{SCLK0} – 2		ns
t_{WADV}	NR_ADV Active Low Width[3]	WST × t_{SCLK0} – 2		ns
t_{HAWE}	Output[4] Hold After $\overline{\text{SMC0\_AWE}}$ High[5]	WHT × t_{SCLK0} – 3.5		ns
t_{WAWE}[6]	$\overline{\text{SMC0\_AWE}}$ Active Low Width[7]	WAT × t_{SCLK0} – 2		ns

[1] PREST value set using the SMC_BxETIM.PREST bits.
[2] PREAT value set using the SMC_BxETIM.PREAT bits.
[3] WST value set using the SMC_BxTIM.WST bits.
[4] Output signals are DATA, SMC0_Ax, $\overline{\text{SMC0\_AMSx}}$, $\overline{\text{SMC0\_ABEx}}$.
[5] WHT value set using the SMC_BxTIM.WHT bits.
[6] SMC_BxCTL.ARDYEN bit = 0.
[7] WAT value set using the SMC_BxTIM.WAT bits.

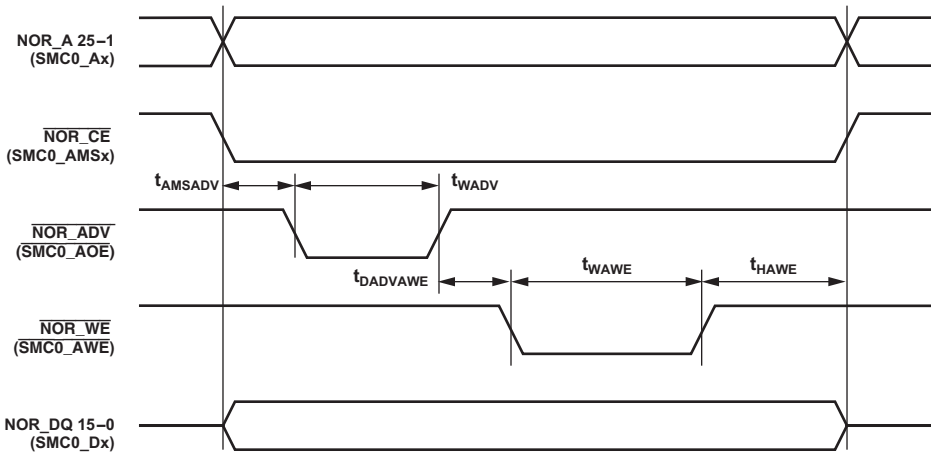

Figure 16. Asynchronous Flash Write

All Accesses

Table 50 describes timing that applies to all memory accesses, related to the SMC.

Table 50. All Accesses

Parameter		Min	Max	Unit
Switching Characteristic				
t_{TURN}	$\overline{\text{SMC0\_AMSx}}$ Inactive Width	(IT + TT) × t_{SCLK0} – 2		ns

Mobile DDR SDRAM Write Cycle Timing

Table 56 and Figure 22 show mobile DDR SDRAM write cycle timing, related to the DMC.

Table 56. Mobile DDR SDRAM Write Cycle Timing, V_{DD_DMCx} Nominal 1.8 V[1]

Parameter		200 MHz[2] Min	200 MHz[2] Max	Unit
Switching Characteristics				
t_{DQSS}[3]	DMCx_DQS Latching Rising Transitions to Associated Clock Edges	0.75	1.25	t_{CK}
t_{DS}	Last Data Valid to DMCx_DQS Delay (Slew > 1 V/ns)	0.48		ns
t_{DH}	DMCx_DQS to First Data Invalid Delay (Slew > 1 V/ns)	0.48		ns
t_{DSS}	DMCx_DQS Falling Edge to Clock Setup Time	0.2		t_{CK}
t_{DSH}	DMCx_DQS Falling Edge Hold Time From DMCx_CK	0.2		t_{CK}
t_{DQSH}	DMCx_DQS Input High Pulse Width	0.4		t_{CK}
t_{DQSL}	DMCx_DQS Input Low Pulse Width	0.4		t_{CK}
t_{WPRE}	Write Preamble	0.25		t_{CK}
t_{WPST}	Write Postamble	0.4		t_{CK}
t_{IPW}	Address and Control Output Pulse Width	2.3		ns
t_{DIPW}	DMCx_DQ and DMCx_DM Output Pulse Width	1.8		ns

[1] Specifications apply to both DMC0 and DMC1.
[2] To ensure proper operation of LPDDR, all the LPDDR guidelines must be strictly followed. See "Interfacing DDR3/DDR2/LPDDR Memory to ADSP-SC5xx/215xx Processors" (EE-387).
[3] Write command to first DMCx_DQS delay = WL × t_{CK} + t_{DQSS}.

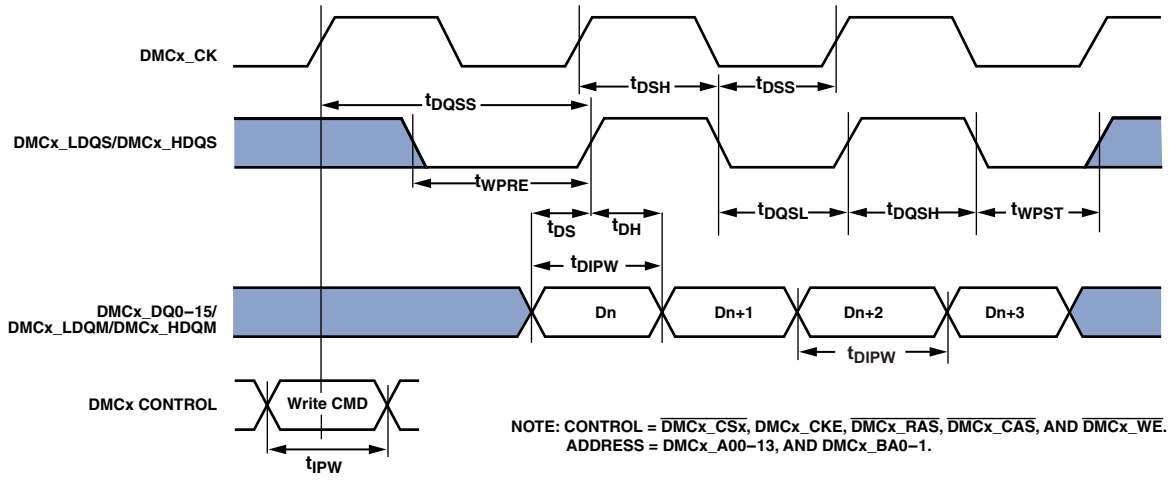

Figure 22. Mobile DDR SDRAM Controller Output AC Timing

DDR3 SDRAM Clock and Control Cycle Timing

Table 57 and Figure 23 show mobile DDR3 SDRAM clock and control cycle timing, related to the DMC.

Table 57. DDR3 SDRAM Clock and Control Cycle Timing VDD_DMCx Nominal 1.5 V[1]

Parameter		450 MHz[2] Min	450 MHz[2] Max	Unit
Timing Requirements				
t_{CK}	Clock Cycle Time (CL = 2 Not Supported)	2.22		ns
$t_{CH(abs)}$[3]	Minimum Clock Pulse Width	0.43	0.57	t_{CK}
$t_{CL(abs)}$[3]	Maximum Clock Pulse Width	0.43	0.57	t_{CK}
t_{IS}	Control/Address Setup Relative to DMCx_CK Rise	0.2		ns
t_{IH}	Control/Address Hold Relative to DMCx_CK Rise	0.275		ns

[1] Specifications apply to both DMC0 and DMC1.
[2] To ensure proper operation of the DDR3, all the DDR3 guidelines must be strictly followed. See "Interfacing DDR3/DDR2/LPDDR Memory to ADSP-SC5xx/215xx Processors" (EE-387).
[3] As per JESD79-3F definition.

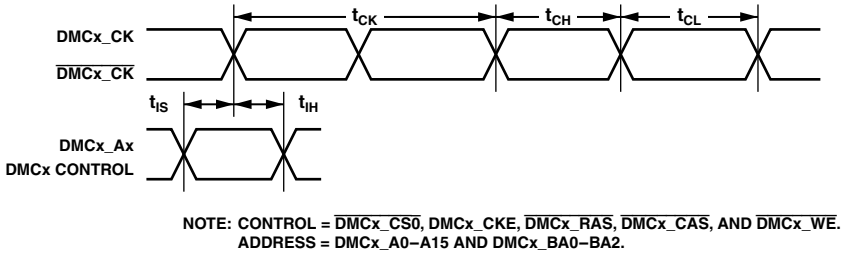

Figure 23. DDR3 SDRAM Clock and Control Cycle Timing

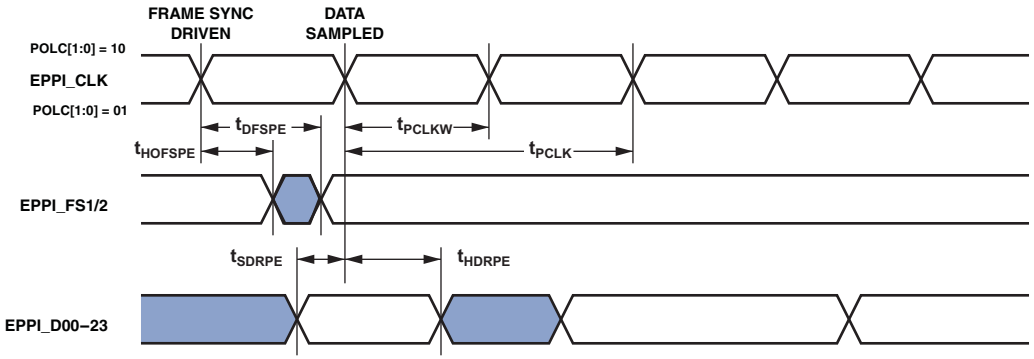

Figure 31. EPPI External Clock GP Receive Mode with Internal Frame Sync Timing

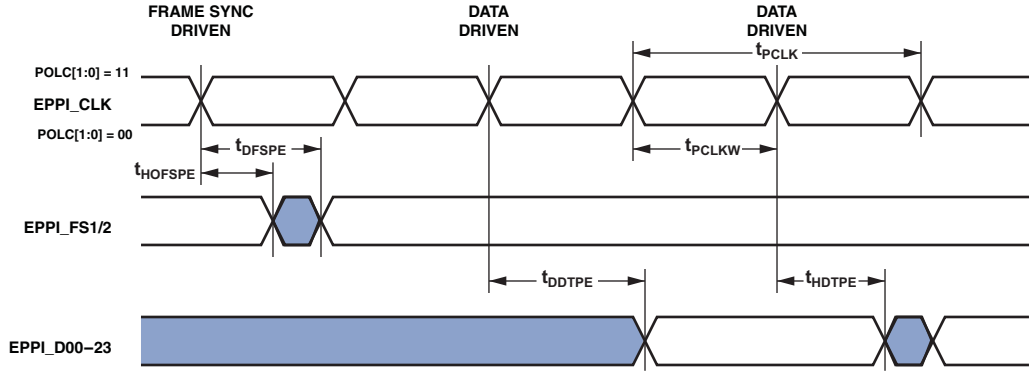

Figure 32. EPPI External Clock GP Transmit Mode with Internal Frame Sync Timing

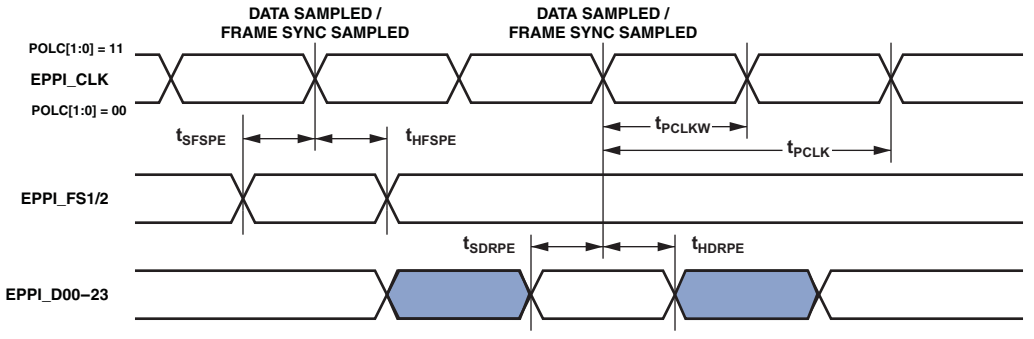

Figure 33. EPPI External Clock GP Receive Mode with External Frame Sync Timing

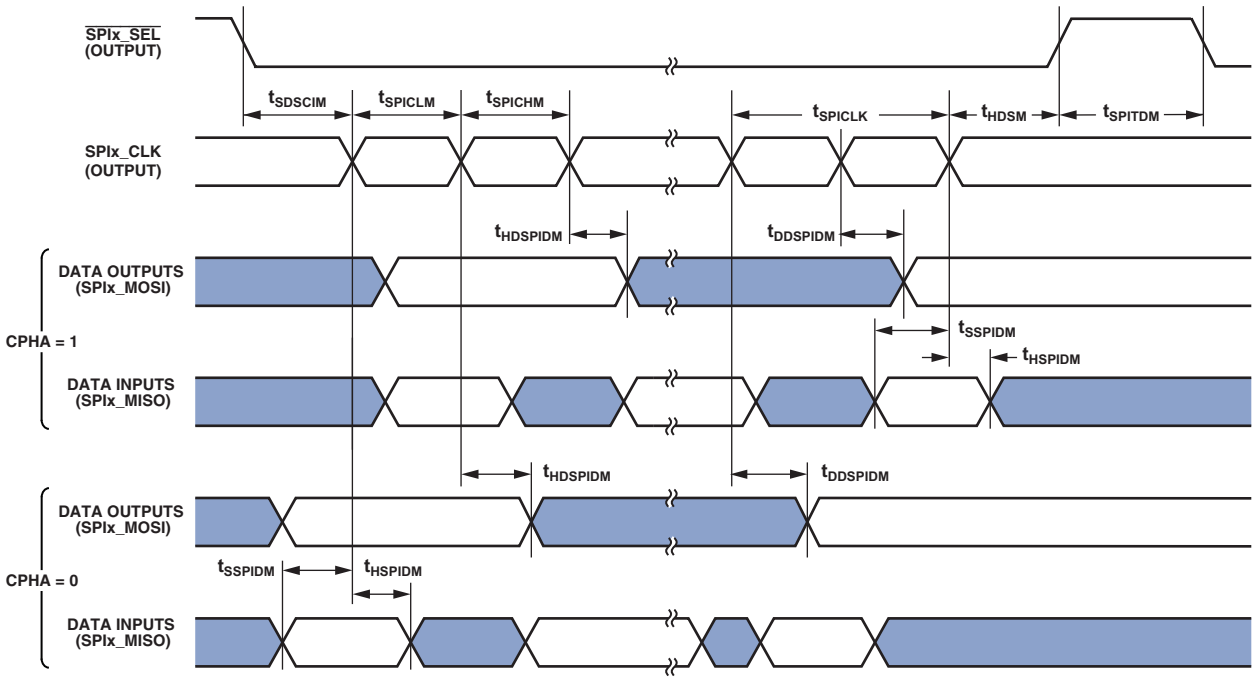

Figure 43. SPI Port—Master Timing

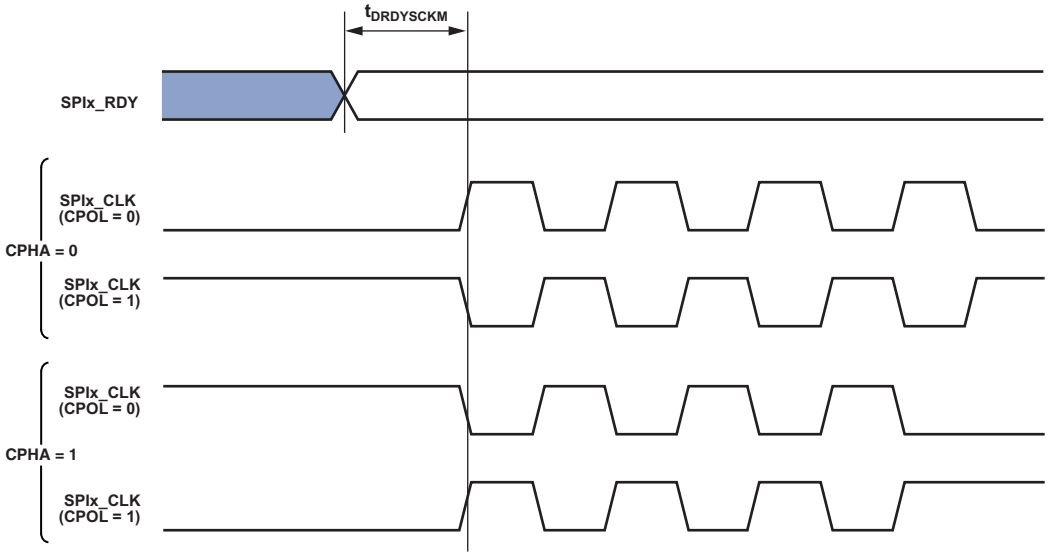

Figure 49. SPIx_CLK Switching Diagram After SPIx_RDY Assertion

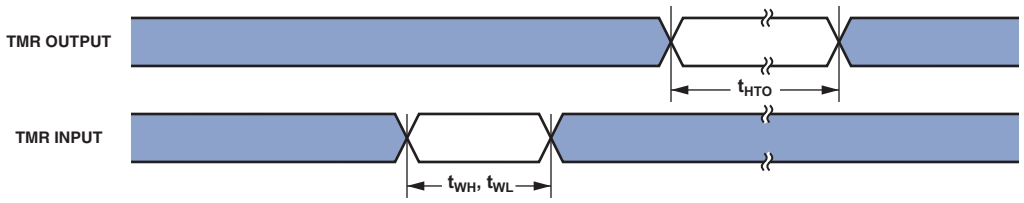

Figure 52. Timer Cycle Timing

DAIx Pin to DAIx Pin Direct Routing (DAI0 Block and DAI1 Block)

Table 81 and Figure 53 describe I/O timing related to the digital audio interface (DAI) for direct pin connections only (for example, DAIx_PB01_I to DAIx_PB02_O).

Table 81. DAI Pin to DAI Pin Routing

Parameter		Min	Max	Unit
Timing Requirement				
t_{DPIO}	Delay DAI Pin Input Valid to DAI Output Valid	1.5	12	ns

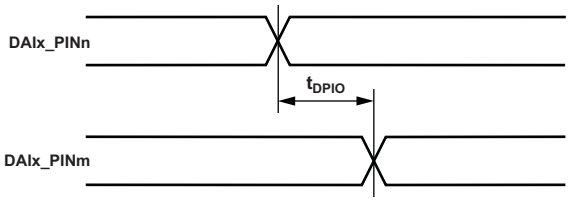

Figure 53. DAI Pin to DAI Pin Direct Routing

Up/Down Counter/Rotary Encoder Timing

Table 82 and Figure 54 describe timing related to the general-purpose counter (CNT).

Table 82. Up/Down Counter/Rotary Encoder Timing

Parameter		Min	Max	Unit
Timing Requirement				
t_{WCOUNT}	Up/Down Counter/Rotary Encoder Input Pulse Width	$2 \times t_{SCLK0}$		ns

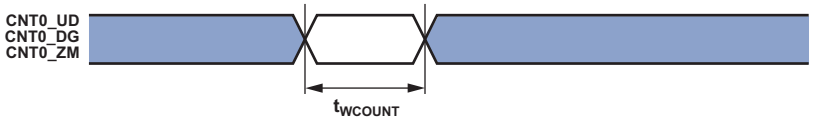

Figure 54. Up/Down Counter/Rotary Encoder Timing

S/PDIF Transmitter Input Data Timing

The timing requirements for the S/PDIF transmitter are given in Table 96. Input signals are routed to the DAIx_PINx pins using the SRU. Therefore, the timing specifications provided below are valid at the DAIx_PINx pins.

Table 96. S/PDIF Transmitter Input Data Timing

Parameter		Min	Max	Unit
Timing Requirements				
t_{SISFS}[1]	Frame Sync Setup Before Serial Clock Rising Edge	3		ns
t_{SIHFS}[1]	Frame Sync Hold After Serial Clock Rising Edge	3		ns
t_{SISD}[1]	Data Setup Before Serial Clock Rising Edge	3		ns
t_{SIHD}[1]	Data Hold After Serial Clock Rising Edge	3		ns
$t_{SITXCLKW}$	Transmit Clock Width	9		ns
$t_{SITXCLK}$	Transmit Clock Period	20		ns
$t_{SISCLKW}$	Clock Width	36		ns
t_{SISCLK}	Clock Period	80		ns

[1] The serial clock, data, and frame sync signals can come from any of the DAI pins. The serial clock and frame sync signals can also come via PCG or SPORTs. The input of the PCG can be either CLKIN or any of the DAI pins.

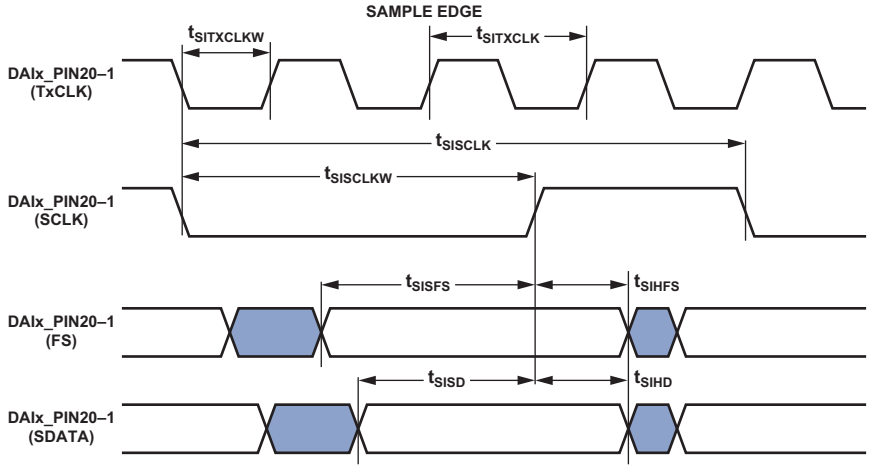

Figure 67. S/PDIF Transmitter Input Timing

Oversampling Clock (TxCLK) Switching Characteristics

The S/PDIF transmitter requires an oversampling clock input. This high frequency clock (TxCLK) input is divided down to generate the internal biphase clock.

Table 97. Oversampling Clock (TxCLK) Switching Characteristics

Parameter		Max	Unit
Switching Characteristics			
f_{TXCLK_384}	Frequency for TxCLK = 384 × Frame Sync	Oversampling ratio × frame sync ≤ $1/t_{SITXCLK}$	MHz
f_{TXCLK_256}	Frequency for TxCLK = 256 × Frame Sync	49.2	MHz
f_{FS}	Frame Rate (FS)	192.0	kHz

Ball No.	Pin Name	Ball No.	Pin Name	Ball No.	Pin Name	Ball No.	Pin Name
T08	GND	V10	VDD_EXT	Y12	HADC0_VIN0	AB14	HADC0_VIN3
T09	GND	V11	VDD_EXT	Y13	HADC0_VIN7	AB15	RTC0_XTAL
T10	GND	V12	HADC0_VIN4	Y14	GND	AB16	MLB0_SIGN
T11	GND	V13	VDD_EXT	Y15	PB_05	AB17	MLB0_DATN
T12	GND	V14	VDD_EXT	Y16	PA_14	AB18	MLB0_CLKN
T13	GND	V15	VDD_EXT	Y17	PA_13	AB19	PA_15
T14	GND	V16	VDD_EXT	Y18	PA_12	AB20	PA_11
T15	GND	V17	VDD_EXT	Y19	PA_10	AB21	PA_06
T16	GND	V18	VDD_EXT	Y20	PA_00	AB22	PA_04
T17	GND	V19	VDD_INT	Y21	DAI1_PIN14	AB23	PA_02
T18	VDD_EXT	V20	DAI1_PIN16	Y22	DAI1_PIN17	AC01	GND
T19	VDD_INT	V21	DAI1_PIN06	Y23	DAI1_PIN15	AC02	PCIE0_RXP
T20	DAI1_PIN03	V22	DAI1_PIN12	AA01	PB_08	AC03	PCIE0_RXM
T21	PG_03	V23	DAI1_PIN09	AA02	PB_07	AC04	PCIE0_CLKM
T22	PG_02	W01	PB_12	AA03	DAI0_PIN16	AC05	PCIE0_CLKP
T23	DAI1_PIN01	W02	PB_09	AA04	DAI0_PIN07	AC06	PCIE0_TXP
U01	SYS_XTAL0	W03	DAI0_PIN18	AA05	DAI0_PIN06	AC07	PCIE0_TXM
U02	$\overline{\text{SYS\_RESOUT}}$	W04	DAI0_PIN11	AA06	DAI0_PIN01	AC08	USB1_DM
U03	PC_00	W05	VDD_INT	AA07	PCIE0_REF	AC09	USB1_DP
U04	DAI0_PIN20	W06	VDD_INT	AA08	USB1_VBUS	AC10	USB0_DP
U05	VDD_INT	W07	VDD_PCIE	AA09	USB0_VBUS	AC11	USB0_DM
U06	VDD_EXT	W08	VDD_INT	AA10	TWI1_SCL	AC12	HADC0_VREFP
U07	GND	W09	VDD_INT	AA11	TWI1_SDA	AC13	VDD_HADC
U08	GND	W10	VDD_INT	AA12	HADC0_VIN1	AC14	GND
U09	GND	W11	VDD_INT	AA13	HADC0_VIN5	AC15	RTC0_CLKIN
U10	GND	W12	HADC0_VIN6	AA14	PB_06	AC16	MLB0_SIGP
U11	GND	W13	VDD_INT	AA15	PB_02	AC17	MLB0_DATP
U12	GND	W14	VDD_RTC	AA16	PB_04	AC18	MLB0_CLKP
U13	GND	W15	VDD_INT	AA17	PB_03	AC19	PB_01
U14	GND	W16	VDD_INT	AA18	PB_00	AC20	PA_07
U15	GND	W17	VDD_INT	AA19	PA_09	AC21	PA_08
U16	GND	W18	VDD_INT	AA20	PA_05	AC22	PA_03
U17	GND	W19	VDD_INT	AA21	PA_01	AC23	GND
U18	VDD_EXT	W20	DAI1_PIN20	AA22	DAI1_PIN19		
U19	DAI1_PIN08	W21	DAI1_PIN11	AA23	DAI1_PIN18		
U20	DAI1_PIN07	W22	DAI1_PIN10	AB01	DAI0_PIN15		
U21	DAI1_PIN04	W23	DAI1_PIN13	AB02	DAI0_PIN14		
U22	DAI1_PIN05	Y01	PB_11	AB03	DAI0_PIN09		
U23	DAI1_PIN02	Y02	PB_10	AB04	DAI0_PIN13		
V01	SYS_CLKIN0	Y03	DAI0_PIN17	AB05	DAI0_PIN04		
V02	PB_13	Y04	DAI0_PIN08	AB06	DAI0_PIN02		
V03	DAI0_PIN19	Y05	DAI0_PIN05	AB07	DAI0_PIN03		
V04	DAI0_PIN12	Y06	DAI0_PIN10	AB08	USB_XTAL		
V05	VDD_INT	Y07	USB0_ID	AB09	USB_CLKIN		
V06	VDD_EXT	Y08	VDD_USB	AB10	TWI2_SCL		
V07	VDD_PCIE_RX	Y09	USB0_VBC	AB11	TWI0_SDA		
V08	VDD_PCIE_TX	Y10	TWI0_SCL	AB12	HADC0_VREFN		
V09	VDD_EXT	Y11	TWI2_SDA	AB13	HADC0_VIN2		